

07-12-01

A

07/10/01  
 J-960 U.S. PTO

skjervén morrill  
 macpherson LLP

Docket No.: M-11706 US

July 10, 2001

Box Patent Application  
 Commissioner For Patents  
 Washington, D. C. 20231

Enclosed herewith for filing is a patent application, as follows:

Inventor(s): Martin, Kirk

Title: Method And Apparatus For Etching A Semiconductor Die

☒ X

Return Receipt Postcard

☒ X

This Transmittal Letter (in duplicate)

☒ 20

page(s) Specification (not including claims)

☒ 7

page(s) Claims

☒ 1

page Abstract

☒ 7

Sheet(s) of Drawings (Figs. 1, 2, 3, 4, 5, 6, 7 and 8)

☒ 1

page(s) Declaration For Patent Application and Power of Attorney

☒ 1

page(s) Recordation Form Cover Sheet (in duplicate)

☒ 1

page(s) Assignment

☒ ☒

Applicant(s) assert(s) entitlement to small entity status for the attached patent application

**CLAIMS AS FILED (fees computed under 37 CFR §1.9(f))**

For	Number Filed			Number Extra		Rate		Basic Fee
Total Claims	34	-20	=	14	x	\$ 9.00	=	\$ 355.00
Independent Claims	5	-3	=	2	x	\$40	=	\$ 80.00

Please make the following charges to Deposit Account 19-2386:

- ☒ Total fee for filing the patent application in the amount of \$ 561.00  
☒ The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account 19-2386.

EXPRESS MAIL LABEL NO:

EL 701 021 920 US

Respectfully submitted,



Robert D. Wasson

Attorney for Applicant(s)

Reg. No. 40,218

J-960 U.S. PTO  
 T6206/60  
 07/10/01